



US 20240251680A1

(19) **United States**

(12) **Patent Application Publication**
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(10) **Pub. No.: US 2024/0251680 A1**

(43) **Pub. Date: Jul. 25, 2024**

(54) **THERMOELECTRIC DEVICE,
THERMOELECTRIC UNIT FOR
THERMOELECTRIC DEVICE, AND ITS
METHOD OF MAKING**

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(21) Appl. No.: **18/156,621**

(22) Filed: **Jan. 19, 2023**

Publication Classification

(51) **Int. Cl.**

H10N 10/857 (2006.01)

H10N 10/01 (2006.01)

H10N 10/17 (2006.01)

H10N 10/852 (2006.01)

(52) **U.S. Cl.**

CPC **H10N 10/857** (2023.02); **H10N 10/01**
(2023.02); **H10N 10/17** (2023.02); **H10N**
10/852 (2023.02)

(57)

ABSTRACT

A thermoelectric unit for a thermoelectric device. The thermoelectric unit includes an architected frame; and a thermoelectric material arrangement deposited or coated on at least part of the architected frame.

